T-3002-M

between chip and substrate at any bond height.

The **T-3002-M** is a manual, precise, high quality die bonder & component placer with superior ergonomic design and a fix die ejector needle. As with all of Tresky's products, the **T-3002-M** incorporates True Vertical Technology™ which guarantees parallelism

True Vertical TechnologyTM

Unique pick-up from wafer

Easy to use







Excellent performance, ergonomically designed and high reliability makes the T-3002-M ideal for small and medium production. Typically with a cycle time of approx. 4 sec. (process depending).

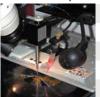
APPLICATIONS:

Die Attach, Die Sorting, Flip-Chip, MEMS, MOEMS, VCSEL, Ultrasonic, Thermosonic, RFID, Adhesive Bonding, Eutectic Bonding (AuAu,),

FEATURES AND OPTIONS:

- TRUE VERTICAL TECHNOLOGY™ Z-movement 95mm with 360° Tool rotation; Dispenser, Stamping, Ultrasonic, Scrub, Tool Heating, Pre Form Spindle, ...
- XY placement stage supporting:
 Waffle / Gel Pack -, Substrate Holder, various Heating
 Plates

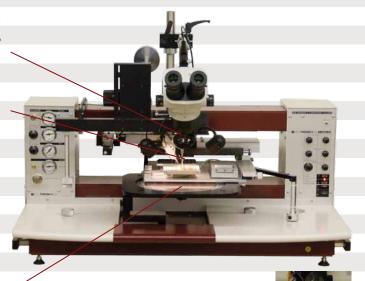
Some examples of XY placement stage configurations:







 Pick-up from Wafer with Tresky's patented die ejector system, especialy suitable for all kind of Si, GaAs and InP dies down to 30µm thickness.



Further Option: Beam Splitter Optics (Flip-Chip09mpaHD)

TECHNICAL DATA:

XY- Movement (placement stage): 220mm x 220mm (manual)
XY- Movement (wafer stage): 220mm x 220mm (manual)

Z- Movement: 95mm (manual)

Spindle Rotation: 360°

Max. PC Board-/ Substrate Size: 400mm x 280mm

Placement accuracy: 10µm; 1µm with high accuracy beam splitter (Flip-Chip09mpa)

Connections: Compressed air 5 - 6 bar / Vacuum 0.6 bar (abs)

Dimensions: 900mm x 800mm x 700mm

Weight: 85kg

Voltage: 110V / 220V

Note: All specifications are subject to change without notice

REPRESENTED BY:



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